

Helping Customers Innovate, Improve & Grow



The MD-013 is a Microchip standard platform module that provides 1 pps TTL, 10 MHz sine wave and 10 MHz square wave outputs that are disciplined to an embedded 72 channel GNSS Receiver. In addition, an external reference input can override the internal receiver as the reference. Internal to the module is a Microchip digitally corrected OCXO.

## Features

- Embedded GNSS Receiver - GPS, GLONASS, Galileo
- 1pps TTL output signal
- 10MHz sinewave and square wave output
- Other RF output frequencies available
- Adaptive aging correction during holdover
- Barometric pressure correction
- Evaluation kit with software
- Serial Communications Interface
- NMEA 0183 V4.1

## Applications

- Basestation Communication
- Digital Video Broadcast
- E911 Location Systems
- General Timing and Synchronization
- Military Radio
- Radar Systems

## Block Diagram

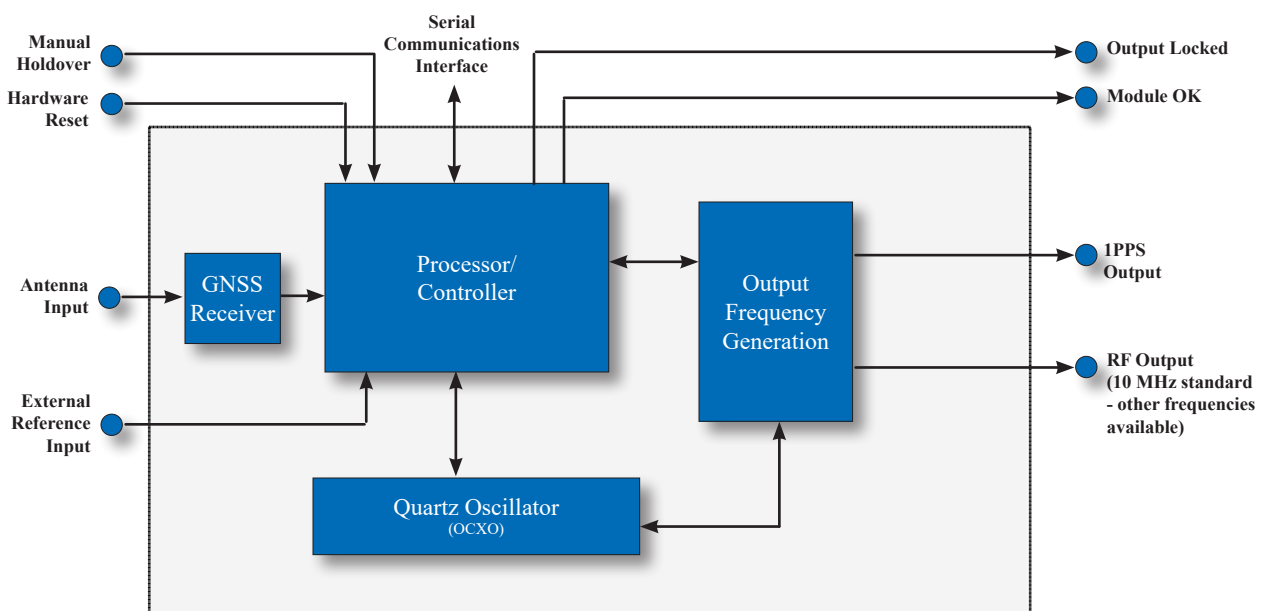


Figure 1. Functional Block Diagram

## Summary Specifications

Comparative Performance of Standard Modules								
Model	Embedded Oscillator	Typical Uses						
MD-013	Digitally Assisted OCXO	Applications requiring 24 hour hold over as low as 1.5 us						
Hold Over Performance <sup>1</sup>								
Hold Over Time	10 min	1 hr	1 hr	1 hr	1 hr	1 hr	24hr	24hr
Hold Over Temperature Change	$\Delta T = 2\text{ }^{\circ}\text{C}$	$\Delta T = 2\text{ }^{\circ}\text{C}$	$\Delta T = 2\text{ }^{\circ}\text{C}$	$\Delta T = 10\text{ }^{\circ}\text{C}$	$\Delta T = 10\text{ }^{\circ}\text{C}$	$\Delta T = 10\text{ }^{\circ}\text{C}$	$\Delta T = 10\text{ }^{\circ}\text{C}$	$\Delta T = 2\text{ }^{\circ}\text{C}$
Model	Maximum Accumulated Hold Over in us							
MD-013	0.05	0.24	0.4	0.4	0.4	0.4	0.4	15E7 option: 1.5 40E7 option: 4.0
Summary Performance Characteristics								
Model	Warm Up Time (min-utes)	Aging / day (ppb) <sup>1</sup>	Temperature Stability (ppb) <sup>2</sup>	Ac-curacy to UTC (+/-1 $\sigma$ ) (ns) <sup>2</sup>	Frequency Accuracy (+/-) <sup>3</sup>	Warm up Power @ 25 °C (W)	Steady State Power @ 25 °C (W)	Voltage (V)
MD-013	7	0.06	0.4	10	<1E-12	7.5	3.6	12
Phase Noise/ ADEV								
	-10 Hz	-100 Hz	-1 kHz	-10 kHz	-100 kHz	ADEV ( $\tau=1s$ )	ADEV ( $\tau=10s$ )	ADEV ( $\tau=100s$ )
MD-013	-125	-140	-145	-145	-145	5E-12	7E-12	6E-12
Internal Receiver Characteristics								
Parameter					Condition			
Type	Timing w/ Self-Survey							
Number of channels	72							
Frequency bands	GPS L1C/A							
	GLONASS L1OF							
	Galileo E1B/C							
	QZSS L1C/A							
	SBAS L1C/A				Disabled by default			
Tracking capability	36 SVs							
Sensitivity	-167 dBm				Tracking (GPS & GLONASS)			
	-148 dBm				Cold Acquisition (GPS & GLONASS)			
	-160 dBm				Reacquisition (GPS & GLONASS)			
Position Accuracy	2.5 meters CEP				GPS & GLONASS, static, -130 dBm, > 6 SVs			
TTF	25 seconds				Cold Start (GPS & GLONASS)			

## Specifications

GPS Antenna					
Parameter	Min	Typical	Max	Units	Condition
Antenna Bias Voltage	4.0	4.8	5.1	$V_{DC}$	
Antenna Current <sup>6</sup>		20	100	mA	
RF Output Waveform Characteristics (via MCX)					
Parameter	Min	Typical	Max	Units	Condition
Waveform	Sinewave				
Output Power	+3.0	+9.0	+11.0	dBm	50 Ohm
Harmonics			-30	dBc	50 Ohm
Spurious			-70	dBc	50 Ohm
RF Output Waveform Characteristics (via pin 8)					
Waveform	HCMOS				
High Level Output Voltage ( $V_{OH}$ )	4.0		5.0	$V_{DC}$	<-0.5mA Load
Low Level Output Voltage ( $V_{OL}$ )		0.0	0.4	$V_{DC}$	<0.5mA Load
Rise/Fall Time		3	5	nSec	15 pF
Duty Cycle	40	50	60	%	15 pF
1pps Output Characteristics (via MCX and pin 2)					
Parameter	Min	Typical	Max	Units	Condition
Waveform	TTL				
High-level output voltage ( $V_{OH}$ )	3.0		5.0	$V_{DC}$	50 Ohms
Low-level output voltage ( $V_{OL}$ )		0.0	0.4	$V_{DC}$	50 Ohms
Pulse Width	9.9	10	10.1	uSec	default setting, user programmable
External 1PPS Reference Input (Pin 1)					
Waveform	TTL				
High-Level Output Voltage ( $V_{OH}$ )	2.0		5.0	$V_{DC}$	50 Ohms input impedance
Low-Level Output Voltage ( $V_{OL}$ )		0.0	0.4	$V_{DC}$	
Pulse width	10			uSec	

## Specifications

Lock Status Indicator (Pin 9) <sup>4</sup>					
Parameter	Min	Typical	Max	Units	Condition
Module Locked	4.5	5.0	5.5	V <sub>DC</sub>	<5mA Load
Module Not Locked	0		0.5	V <sub>DC</sub>	<5mA Load
Module Hardware OK Indicator (Pin 10) <sup>5</sup>					
Module Hardware OK	4.5	5.0	5.5	V <sub>DC</sub>	<5mA Load
Module Hardware Failure	0		0.5	V <sub>DC</sub>	<5mA Load
Module Hardware Reset (Pin 12)					
Reset Module	0		0.5	V <sub>DC</sub>	10 kOhm internal pullup
Manual Holdover Set (Pin 11)					
Enter Manual Holdover	0		0.5	V <sub>DC</sub>	5.6 kOhm internal pullup
Serial Communications Interface <sup>7</sup>					
Rx high-level input voltage (V <sub>IH</sub> )	4.5	5.0	5.5	V <sub>DC</sub>	
Rx low-level input voltage (V <sub>IL</sub> )	-0.5		0.5	V <sub>DC</sub>	
Tx high-level output voltage (V <sub>OH</sub> )	4.5	5.0	5.5	V <sub>DC</sub>	
Tx low-level output voltage (V <sub>OL</sub> )	-0.5		0.5	V <sub>DC</sub>	
Update rate		1		Hz	User configurable from 0 to 255 seconds
Communications Protocol	VSIP2/NMEA 0183 V4.1			See VSIP2 for Full Details	
Supply Voltage (Pin 7,15,16)					
Supply voltage	+11.4	+12	+12.6	V <sub>DC</sub>	
Absolute Maximum Ratings					
Supply voltage (V <sub>S</sub> )			15	V <sub>DC</sub>	
Dc voltage on any I/O pin			5.5	V	
Output load	10			Ohms	
AC ripple			50	mVpk-pk	10Hz to 1MHz

## Specifications

Environmental Conditions					
Parameter	Min	Typical	Max	Units	Condition
Operating temperature	-40		+85	°C	
Humidity @ 40°C			90	%	
Storage Temperature	-55		+125	°C	
Physical Characteristics					
Weight			120	g	

## Reliability

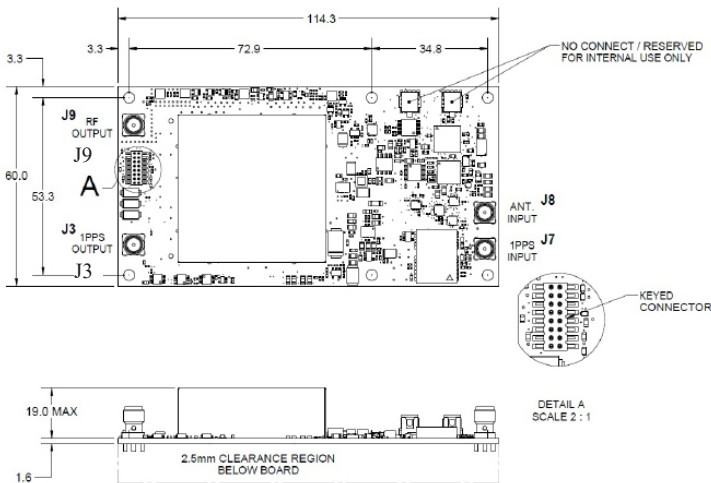
Microchip qualification includes aging various extreme temperatures, shock and vibration, temperature cycling, and IR reflow simulation. The MD-013 family is capable of meeting the following qualification tests:

Environmental Compliance	
Parameter	Conditions
Mechanical shock	MIL-STD-202, Method 213 condition B (75G, 6ms)
Mechanical vibration	MIL-STD-202, Method 204 condition A (10G peak, 10-500)
Resistance to solvents	MIL-STD-202, Method 215
Altitude	-2,500 to 27,900 feet

Although ESD protection circuitry has been designed into the MD-013 proper precautions should be taken when handling and mounting. Microchip employs a human body model (HBM) and a charged-device model (CDM) for ESD susceptibility testing and design protection

ESD Ratings		
Model	Minimum	Conditions
Human body model	1500 V	MIL-STD-883C, Method 3015
Charged device model	1000 V	JEDEC, JESD22-C101

## Package Outline



16 Pin I/O Connections		
Number	Name	Description
1	Ref In	External Reference Input
2	PPS Out	1 PPS Output
3	Ground	Ground
4	Ground	Ground
5	Rx	Serial Communications Receive
6	Tx	Serial Communications Transmit
7	Vcc	Power Supply
8	RF Out	RF HCMOS Output
9	Locked	Logic-high = Output locked to GPS
10	Module OK	Logic low = Failure with module operation
11	ManHold	Manual Holdover Input
12	Reset	Hardware reset
13	Ground	Ground
14	Ground	Ground
15	Vcc	Power Supply
16	Vcc	Power Supply

**Notes:**

- RF and 1pps input and output connectors are MCX type (SMA, SMB, MMCX connectors require additional part numbers).
- Keyed connector is Samtec FTSH-108-01LDVK type.
- Dimensions: mm
- Module height in part number is the sum of oscillator height, board, and clearance

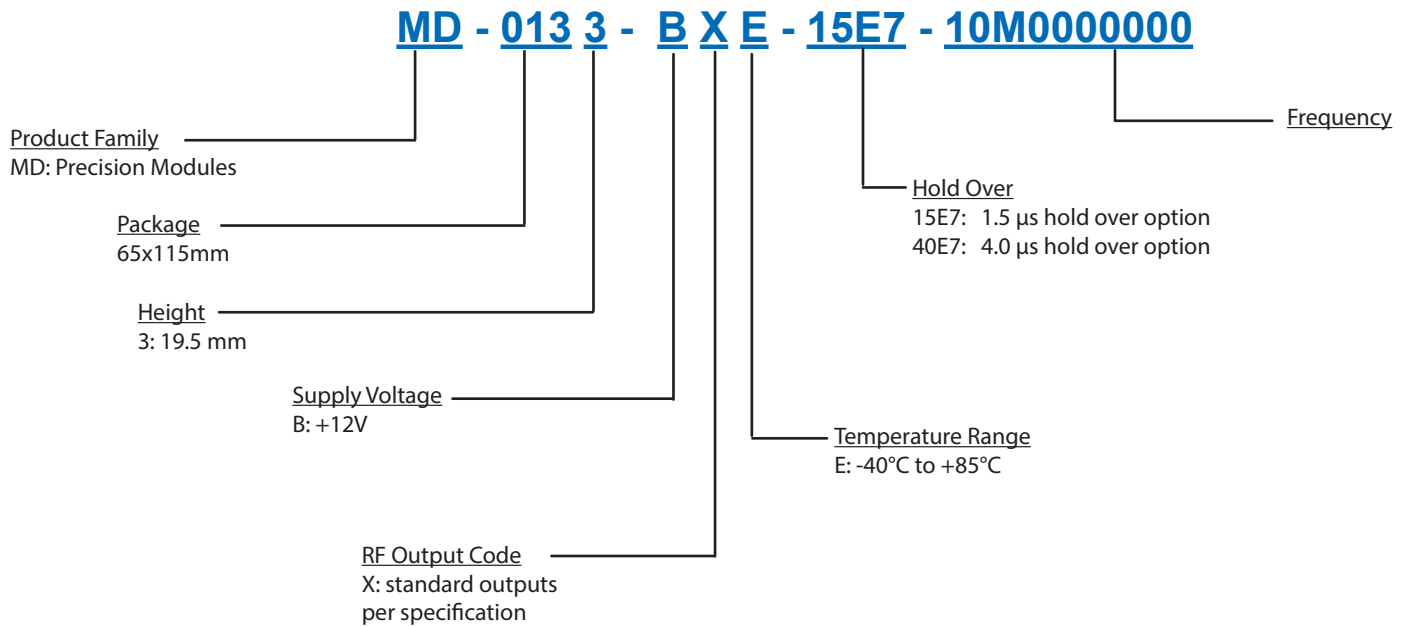
## Accessories

Microchip Partnumber	Description
MD-013-EK	MD-013X-XXX-XXXX Module with Evaluation Kit

## Ordering Information Instructions

Customization to unique customer requirements is available and is common for this level of integration. Common customizations include alternate output frequencies, temperature ranges, differing values and methods of hold over specification, and holdover optimization in the frequency domain. The table below lists existing combinations available as of the date of publication of this data sheet. Please contact the factory for additional options.

## Ordering Information



### Available Models

<b>MD-0133-BXE-15E7-10M0000000</b>	<b>MD-0133-BXE-40E7-10M0000000</b>
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## Notes

- 1) Holdover and aging performance is after 7 days of power-on time. Temperature and aging rates are when device is not locked. Performance measured in still air.
- 2) After customer applies correct offset using cable delay command while locked, after 24 hours of locked operation
- 3) ADEV at  $\tau=86400s$  while locked to GPS, after 24 hours of locked operation
- 4) The status locked indicator is intended to indicate when the module is fully locked to a reference.
- 5) The Hardware OK indicator is intended to indicate when the module is operating properly without any failures, including hardware, software or parameter out of range.
- 6) Antenna over current flag will be set if maximum current is exceeded. Circuit has overcurrent protection.
- 7) The Rx pin is the serial interface input and the Tx pin is the serial interface output. The serial interface shall operate at 115,200 baud with eight (8) data bits, one (1) stop bit and no parity.

## Contact Information

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